

N-Channel JFETs

2N5484	SST5484
2N5485	SST5485
2N5486	SST5486

PRODUCT SUMMARY					
Part Number	$V_{GS(off)}$ (V)	$V_{(BR)GSS}$ Min (V)	g_{fs} Min (mS)	I_{DSS} Min (mA)	
2N/SST5484	-0.3 to -3	-25	3	1	
2N/SST5485	-0.5 to -4	-25	3.5	4	
2N/SST5486	-2 to -6	-25	4	8	

FEATURES

- Excellent High-Frequency Gain: Gps 13 dB (typ) @ 400 MHz – 5485/6
- Very Low Noise: 2.5 dB (typ) @ 400 MHz – 5485/6
- Very Low Distortion
- High AC/DC Switch Off-Isolation

BENEFITS

- Wideband High Gain
- Very High System Sensitivity
- High Quality of Amplification
- High-Speed Switching Capability
- High Low-Level Signal Amplification

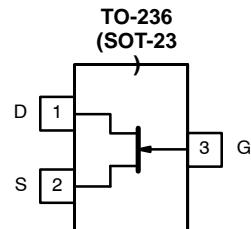
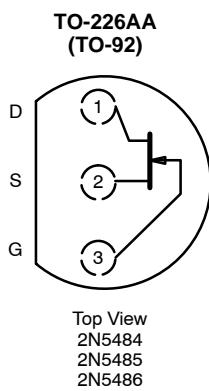
APPLICATIONS

- High-Frequency Amplifier/Mixer
- Oscillator
- Sample-and-Hold
- Very Low Capacitance Switches

DESCRIPTION

The 2N/SST5484 series consists of n-channel JFETs designed to provide high-performance amplification, especially at high frequencies up to and beyond 400 MHz.

The 2N series, TO-226AA (TO-92), and SST series, TO-236 (SOT-23), packages provide low-cost options and are available with tape-and-reel to support automated assembly (see Packaging Information).



Top View
SST5484 (H4)*
SST5485 (H5)*
SST5486 (H6)*

*Marking Code for TO-236

For applications information see AN102 and AN105.

ABSOLUTE MAXIMUM RATINGS

Gate-Drain, Gate-Source Voltage	-25 V	Operating Junction Temperature	-55 to 150°C
Gate Current	10 mA	Power Dissipation ^a	350 mW
Lead Temperature	300°C	Notes	
Storage Temperature	-65 to 150°C	a.	Derate 2.8 mW/°C above 25°C

SPECIFICATIONS FOR 2N SERIES (T _A = 25°C UNLESS OTHERWISE NOTED)											
Parameter	Symbol	Test Conditions	Typ ^a	Limits						Unit	
				2N5484	2N5485	2N5486	Min	Max	Min		
Static											
Gate-Source Breakdown Voltage	V _{(BR)GSS}	I _G = -1 μA, V _{DS} = 0 V	-35	-25		-25		-25		V	
Gate-Source Cutoff Voltage	V _{GS(off)}	V _{DS} = 15 V, I _D = 10 nA		-0.3	-3	-0.5	-4	-2	-6		
Saturation Drain Current ^b	I _{DSS}	V _{DS} = 15 V, V _{GS} = 0 V		1	5	4	10	8	20	mA	
Gate Reverse Current	I _{GSS}	V _{GS} = -20 V, V _{DS} = 0 V T _A = 100°C	-0.002 -0.2		-1		-1		-1	nA	
Gate Operating Current ^c	I _G	V _{DG} = 10 V, I _D = 1 mA	-20							pA	
Gate-Source Forward Voltage ^c	V _{GS(F)}	I _G = 10 mA, V _{DS} = 0 V	0.8							V	
Dynamic											
Common-Source Forward Transconductance ^{NO TAG}	g _{fs}	V _{DS} = 15 V, V _{GS} = 0 V f = 1 kHz			3	6	3.5	7	4	ms	
Common-Source Output Conductance ^{NO TAG}	g _{os}				50		60		75	μS	
Common-Source Input Capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V f = 1 MHz	2.2		5		5		5		
Common-Source Reverse Transfer Capacitance	C _{rss}		0.7		1		1		1	pF	
Common-Source Output Capacitance	C _{oss}		1		2		2		2		
Equivalent Input Noise Voltage ^c	ē _n	V _{DS} = 15 V, V _{GS} = 0 V f = 100 Hz	10							nV/√Hz	
High-Frequency											
Common-Source Transconductance ^d	Y _{fs(RE)}	V _{DS} = 15 V V _{GS} = 0 V	f = 100 MHz	5.5	2.5					ms	
Common-Source Output Conductance ^d	Y _{os(RE)}		f = 400 MHz	5.5		3		3.5		μS	
Common-Source Input Conductance ^d	Y _{is(RE)}		f = 100 MHz	45	75					ms	
Common-Source Power Gain ^d	G _{ps}		f = 400 MHz	65		100		100			
			f = 100 MHz	0.05	0.1						
			f = 400 MHz	0.8			1		1		
Noise Figure ^d	NF	V _{DS} = 15 V, I _D = 1 mA f = 100 MHz		20	16	25				dB	
		V _{DS} = 15 V I _D = 4 mA	f = 100 MHz	21		18	30	18	30		
			f = 400 MHz	13		10	20	10	20		
		V _{DS} = 15 V, V _{GS} = 0 V R _G = 1 MΩ, f = 1 kHz		0.3	2.5		2.5		2.5		
		V _{DS} = 15 V, I _D = 1 mA R _G = 1 kΩ, f = 100 MHz		2	3						
		V _{DS} = 15 V I _D = 4 mA R _G = 1 kΩ	f = 100 MHz	1			2		2		
			f = 400 MHz	2.5			4		4		

**SPECIFICATIONS FOR SST SERIES ($T_A = 25^\circ C$ UNLESS OTHERWISE NOTED)**

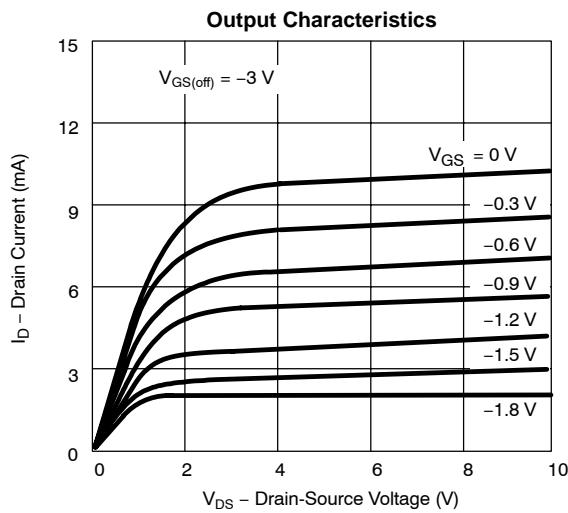
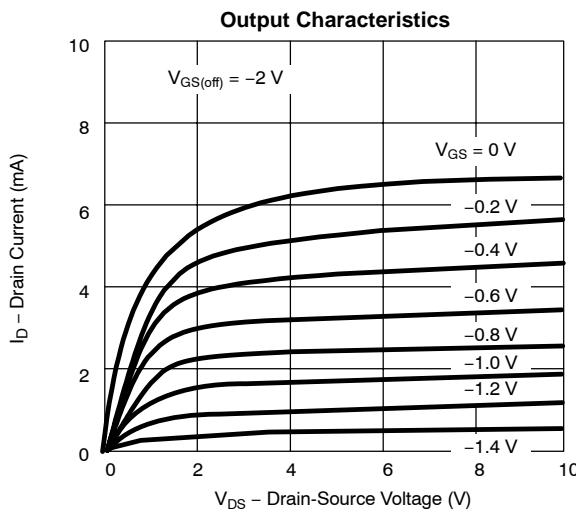
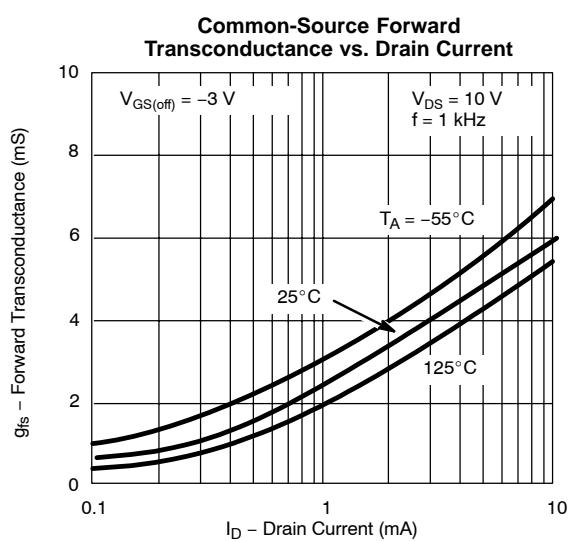
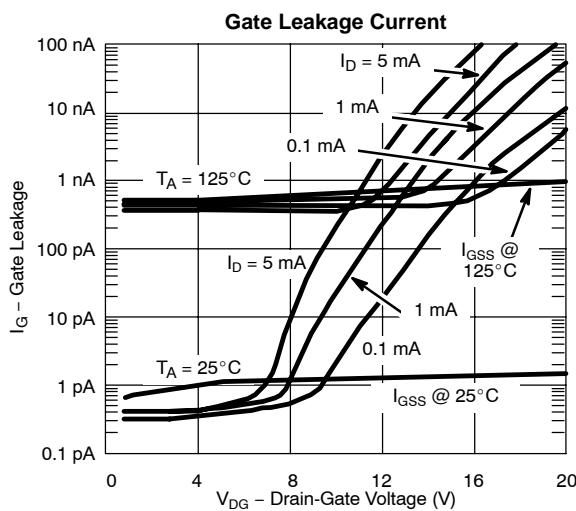
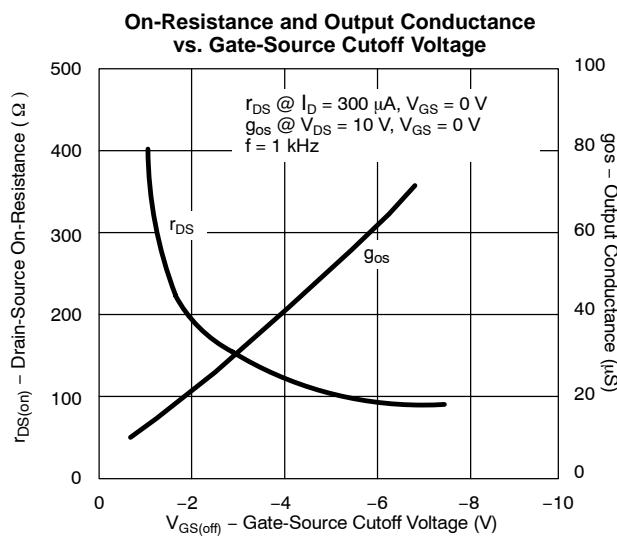
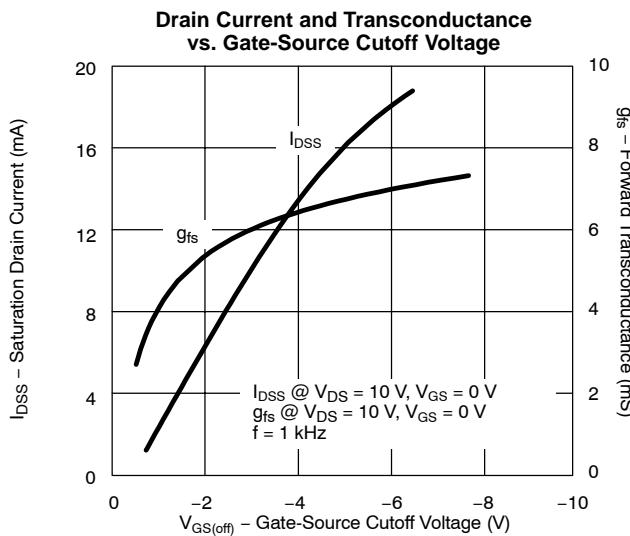
Parameter	Symbol	Test Conditions	Typ ^b	Limits						Unit	
				SST5484		SST5485		SST5486			
				Min	Max	Min	Max	Min	Max		
Static											
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = -1 \mu A, V_{DS} = 0 V$	-35	-25		-25		-25		V	
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 15 V, I_D = 10 nA$		-0.3	-3	-0.5	-4	-2	-6		
Saturation Drain Current ^b	I_{DSS}	$V_{DS} = 15 V, V_{GS} = 0 V$		1	5	4	10	8	20	mA	
Gate Reverse Current	I_{GSS}	$V_{GS} = -20 V, V_{DS} = 0 V$ $T_A = 100^\circ C$	-0.002 -0.2		-1 -200		-1 -200		-1 -200	nA	
Gate Operating Current ^c	I_G	$V_{DG} = 10 V, I_D = 1 mA$	-20							pA	
Gate-Source Forward Voltage ^c	$V_{GS(F)}$	$I_G = 10 mA, V_{DS} = 0 V$	0.8							V	
Dynamic											
Common-Source Forward Transconductance ^{NO TAG}	g_{fs}	$V_{DS} = 15 V, V_{GS} = 0 V$ $f = 1 kHz$			3	6	3.5	7	4	8	mS
Common-Source Output Conductance ^{NO TAG}	g_{os}				50		60		75		μS
Common-Source Input Capacitance	C_{iss}	$V_{DS} = 15 V, V_{GS} = 0 V$ $f = 1 MHz$	2.2							pF	
Common-Source Reverse Transfer Capacitance	C_{rss}		0.7								
Common-Source Output Capacitance	C_{oss}		1								
Equivalent Input Noise Voltage ^e	\bar{e}_n	$V_{DS} = 15 V, V_{GS} = 0 V$ $f = 100 Hz$	10							nV/\sqrt{Hz}	
High-Frequency											
Common-Source Transconductance	Y_{fs}	$V_{DS} = 15 V$ $V_{GS} = 0 V$	$f = 100 MHz$	5.5						mS	
Common-Source Output Conductance	Y_{os}		$f = 400 MHz$	5.5							
Common-Source Input Conductance	Y_{is}		$f = 100 MHz$	45							
Common-Source Power Gain	G_{ps}		$f = 400 MHz$	65							
			$f = 100 MHz$	0.05						mS	
			$f = 400 MHz$	0.8							
Noise Figure	NF	$V_{DS} = 15 V, I_D = 1 mA$ $f = 100 MHz$		20						dB	
		$V_{DS} = 15 V$ $I_D = 4 mA$	$f = 100 MHz$	21							
			$f = 400 MHz$	13							
Noise Figure	NF	$V_{DS} = 15 V, V_{GS} = 0 V$ $R_G = 1 M\Omega, f = 1 kHz$		0.3						dB	
		$V_{DS} = 15 V, I_D = 1 mA$ $R_G = 1 k\Omega, f = 100 MHz$		2							
			$f = 100 MHz$	1							
		$V_{DS} = 15 V$ $I_D = 4 mA$ $R_G = 1 k\Omega$	$f = 400 MHz$	2.5							

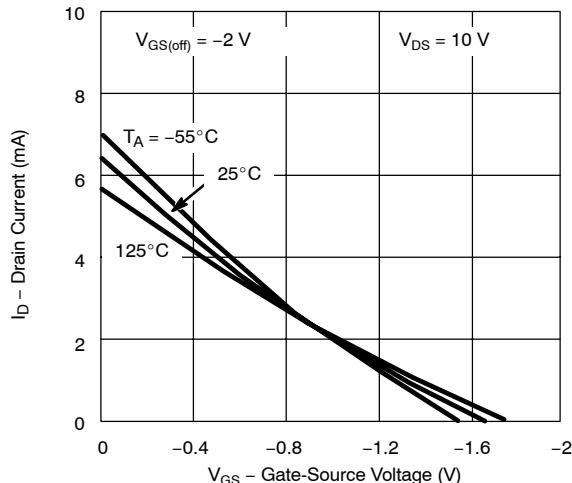
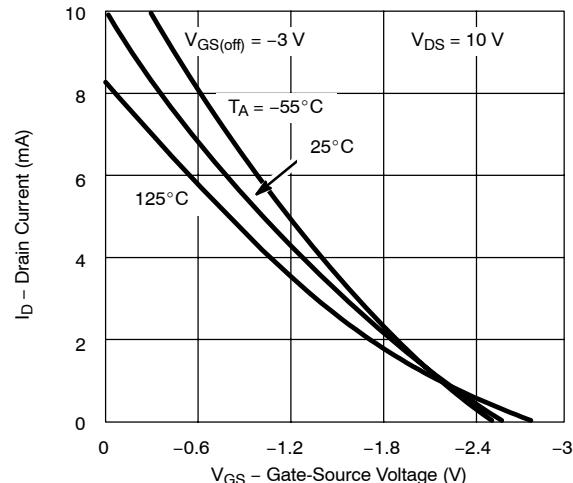
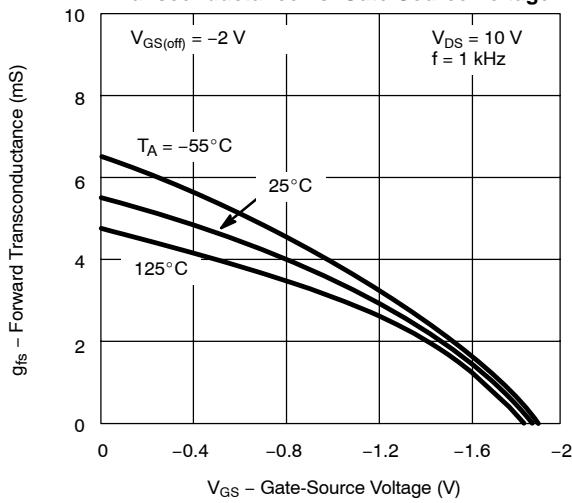
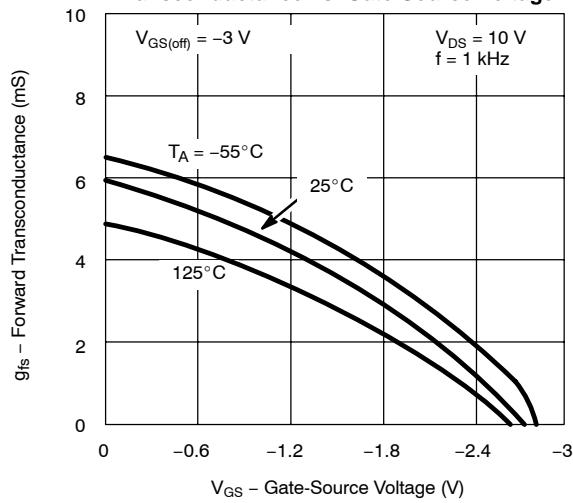
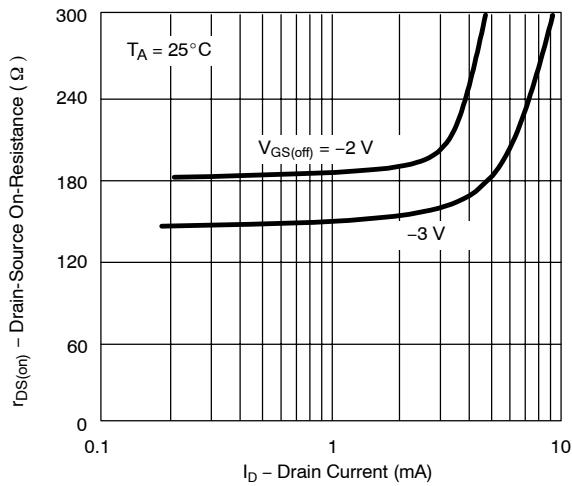
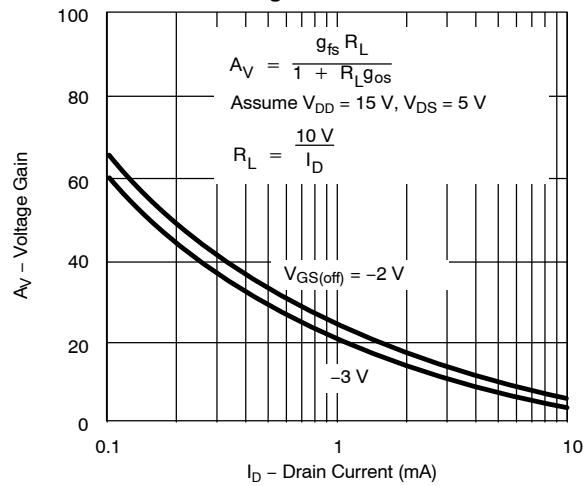
Notes

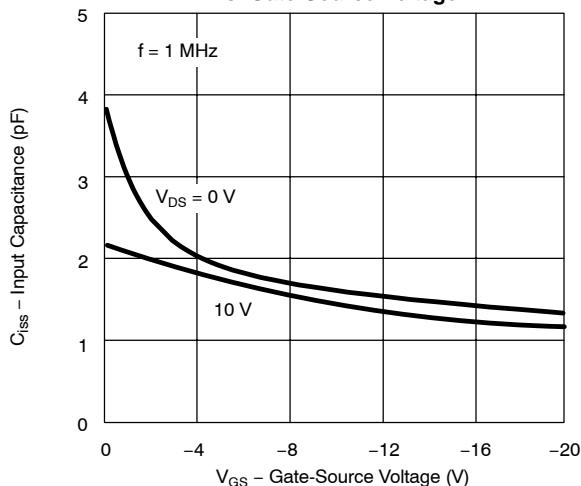
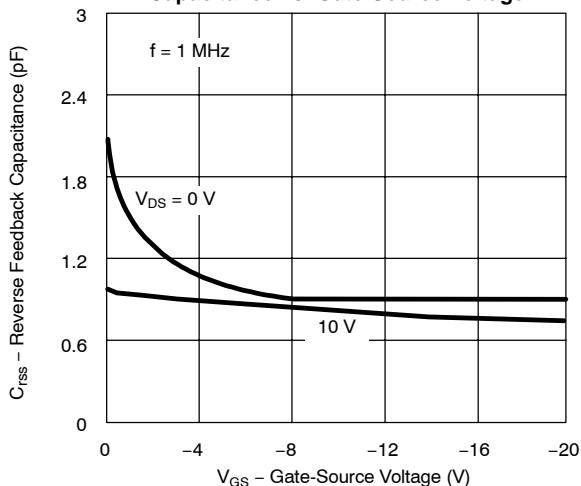
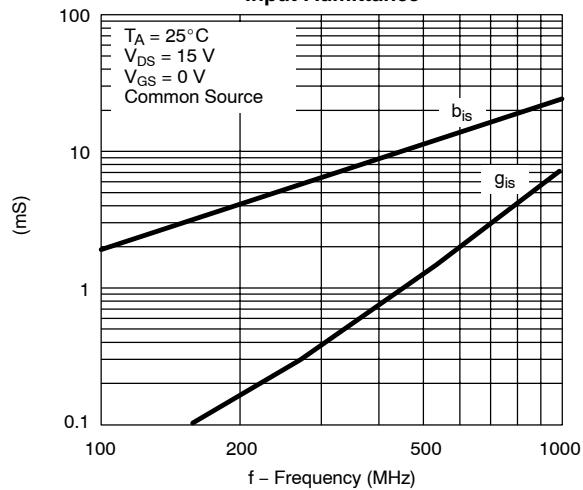
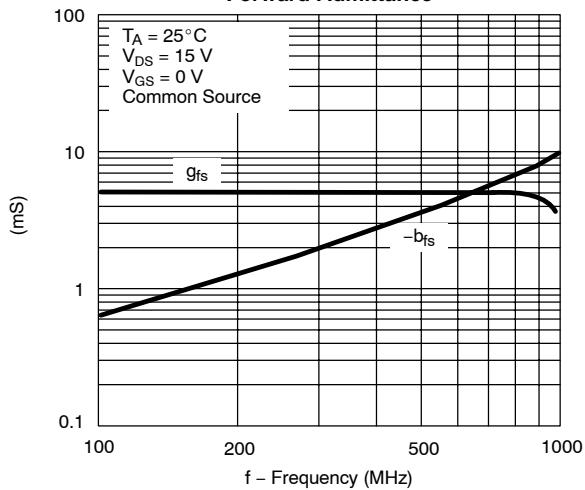
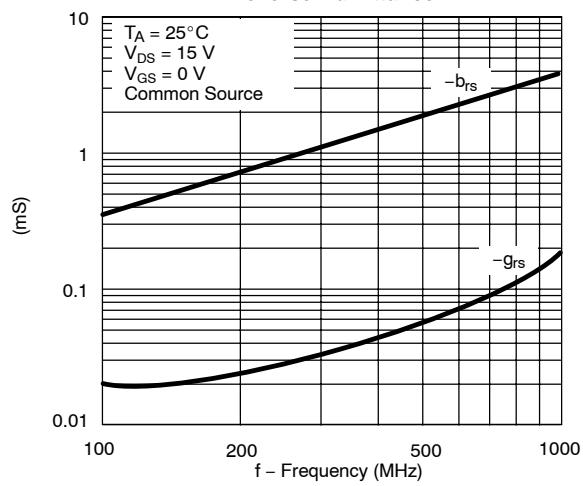
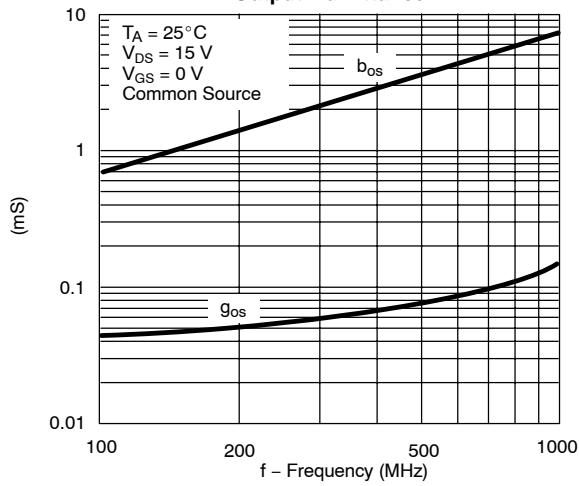
- a. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- b. Pulse test: PW $\leq 300 \mu s$ duty cycle $\leq 3\%$.
- c. This parameter not registered with JEDEC.
- d. Not a production test.

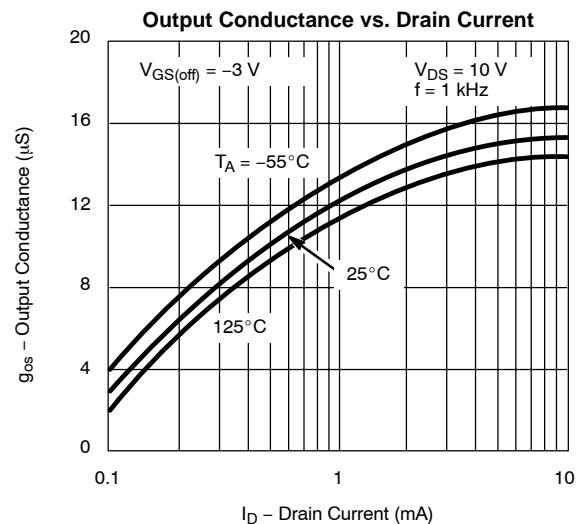
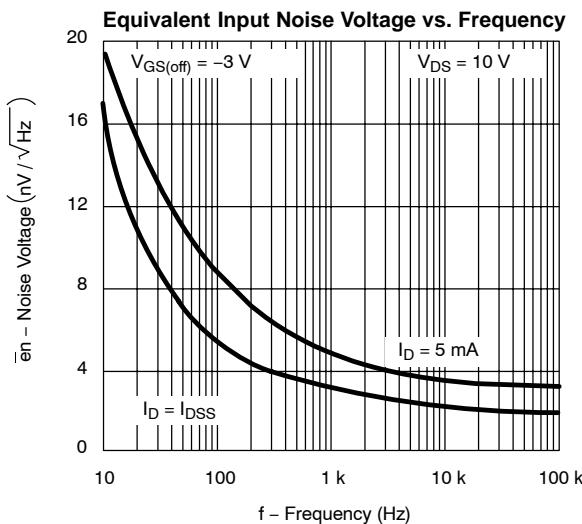
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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)
Transfer Characteristics

Transfer Characteristics

Transconductance vs. Gate-Source Voltage

Transconductance vs. Gate-Source Voltage

On-Resistance vs. Drain Current

Circuit Voltage Gain vs. Drain Current


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)
Common-Source Input Capacitance vs. Gate-Source Voltage

Common-Source Reverse Feedback Capacitance vs. Gate-Source Voltage

Input Admittance

Forward Admittance

Reverse Admittance

Output Admittance


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)


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